

Insulated Gate Bi-Polar Transistor

Type T0258HF65G

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{CES}	Collector – emitter voltage	6500	V
V _{CES}	Collector – emitter voltage (T _j 25°C)	6500	V
V _{CES}	Collector – emitter voltage (T _j -40°C)	6000	V
V _{DC link}	Permanent DC voltage for 100 FIT failure rate.	3600	V
V _{GES}	Peak gate – emitter voltage	±20	V

	RATINGS	MAXIMUM LIMITS	UNITS
I _C	DC collector current, IGBT	258	A
I _{CRM}	Repetitive peak collector current, t _p =1ms, IGBT	516	A
I _{F(DC)}	Continuous DC forward current, Diode	258	A
I _{FRM}	Repetitive peak forward current, t _p =1ms, Diode	516	A
I _{FSM}	Peak non-repetitive surge t _p =10ms, V _{RM} =60%V _{RRM} , Diode (Note 4)	2110	A
I _{FSM2}	Peak non-repetitive surge t _p =10ms, V _{RM} ≤10V, Diode (Note 4)	2320	A
P _{MAX}	Maximum power dissipation, IGBT (Note 2)	3	KW
(di/dt) _{cr}	Critical diode di/dt (note 3)	1000	A/μs
T _j	Operating temperature range.	-40 to +125	°C
T _{stg}	Storage temperature range.	-40 to +125	°C

Notes: -

- 1) Unless otherwise indicated T_j = 125°C.
- 2) T_{sink} = 25°C, double side cooled.
- 3) Maximum commutation loop inductance 1000nH.
- 4) Half-sinewave, 125°C T_j initial.

Characteristics

IGBT Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
$V_{CE(sat)}$	Collector – emitter saturation voltage	-	3.6	-	$I_C = 258A, V_{GE} = 15V, T_J = 25^\circ C$	V
		4.4	4.8	5.2	$I_C = 258A, V_{GE} = 15V$	V
V_{T0}	Threshold voltage	-		2.49	Current range: 86A – 258A	V
r_T	Slope resistance	-		10.5		m Ω
$V_{GE(TH)}$	Gate threshold voltage	-	5.2	-	$V_{CE} = V_{GE}, I_C = 258mA$	V
I_{CES}	Collector – emitter cut-off current	-	2.5	10	$V_{CE} = V_{CES}, V_{GE} = 0V$	mA
I_{GES}	Gate leakage current	-	-	20	$V_{GE} = \pm 20V$	μA
C_{ies}	Input capacitance	-	45	-	$V_{CE} = 10V, V_{GE} = 0V, f = 100kHz, T_J = 25^\circ C$	nF
$t_{d(on)}$	Turn-on delay time	-	1.7	-	$I_C = 258A, V_{CE} = 3600V, di/dt = 700A/\mu s$	μs
$t_r(V)$	Rise time	-	3.5	-		μs
$Q_{g(on)}$	Turn-on gate charge	-	1.5	-	$V_{GE} = \pm 15V, L_s = 1000nH$	μC
E_{on}	Turn-on energy	-	1.8	-	$R_{g(ON)} = 12\Omega, R_{g(OFF)} = 36\Omega, C_{GE} = 22nF$	J
$t_{d(off)}$	Turn-off delay time	-	5.0	-	Integral diode used as freewheel diode (Note 3 & 4)	μs
$t_f(I)$	Fall time	-	2.2	-		μs
$Q_{g(off)}$	Turn-off gate charge	-	2.5	-		μC
E_{off}	Turn-off energy	-	1.45	-		J
I_{sc}	Short circuit current	-	1400	-	$V_{GE} = +15V, V_{CC} = 3600V, V_{CEmax} \leq V_{CES}, t_p \leq 10\mu s$	A

Diode Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
V_F	Forward voltage	-	3.1	-	$I_F = 258A, T_J = 25^\circ C$	V
		-	3.45	3.85	$I_F = 258A$	V
V_{T0}	Threshold voltage	-	-	1.89	Current range 86A – 258A	V
r_T	Slope resistance	-	-	7.6		m Ω
I_{rm}	Peak reverse recovery current	-	300	-	$V_F = 3600V, I_F = 258A, V_{GE} = -15V, di/dt = 700A/\mu s$	A
Q_{rr}	Recovered charge	-	410	-		μC
t_{rr}	Reverse recovery time, 50% chord	-	1.2	-		μs
E_r	Reverse recovery energy	-	0.6	-		J

Thermal Characteristics

	PARAMETER	MIN	TYP	MAX	TEST CONDITIONS	UNITS
R_{thJK}	Thermal resistance junction to sink, IGBT	-	-	32.8	Double side cooled	K/kW
		-	-	49.4	Collector side cooled	K/kW
		-	-	98	Emitter side cooled	K/kW
R_{thJK}	Thermal resistance junction to sink, Diode	-	-	56.7	Double side cooled	K/kW
		-	-	82	Cathode side cooled	K/kW
		-	-	183	Anode side cooled	K/kW
F	Mounting force	12	-	16	Note 2	kN
W_t	Weight	-	825	-		g

Notes:-

- 1) Unless otherwise indicated $T_J = 125^\circ C$.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C_{GE} is additional gate – emitter capacitance added to output of gate drive
- 4) Figures 6 to 9 are obtained using integral diode as freewheeling diode

Curves

Figure 1 – Typical collector-emitter saturation voltage characteristics

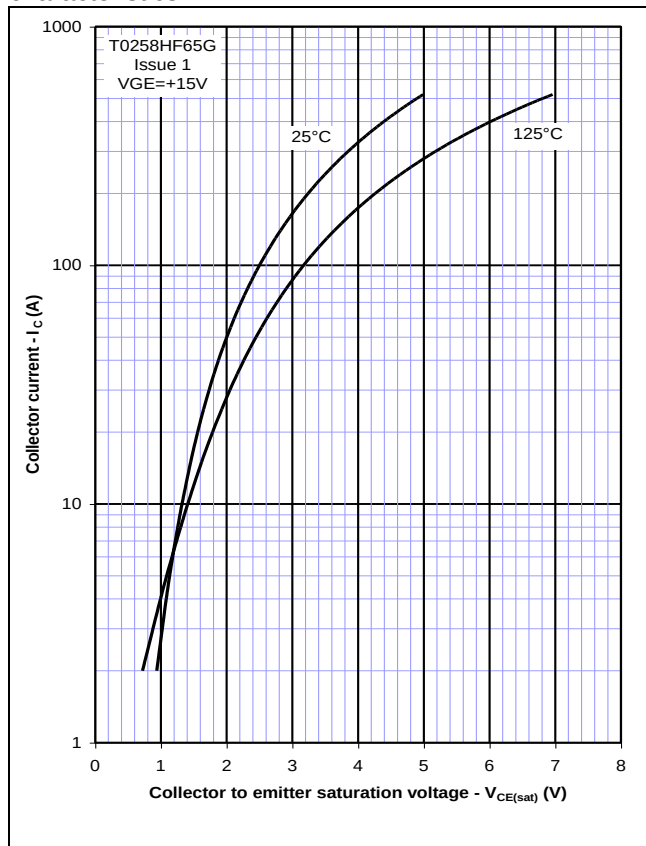


Figure 2 – Typical output characteristic

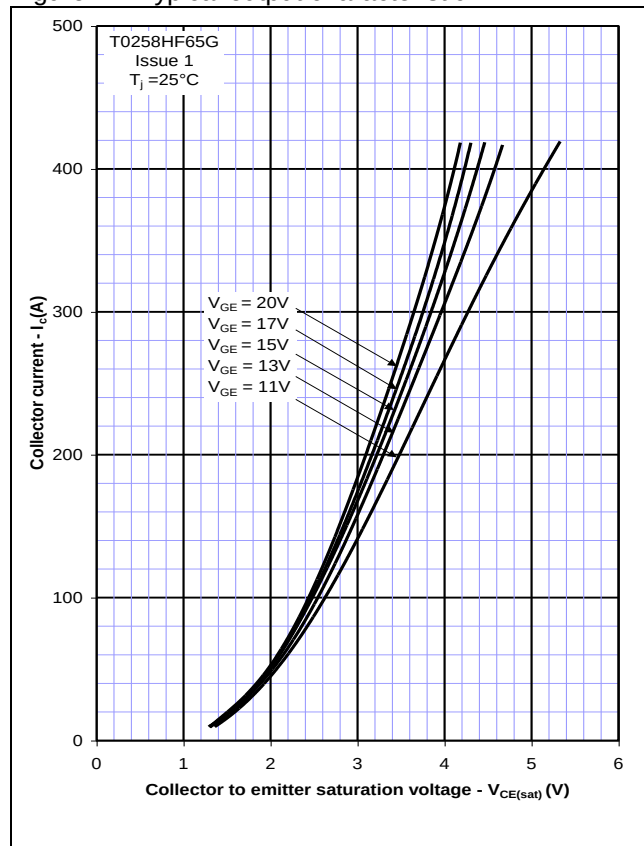


Figure 3 – Typical output characteristic

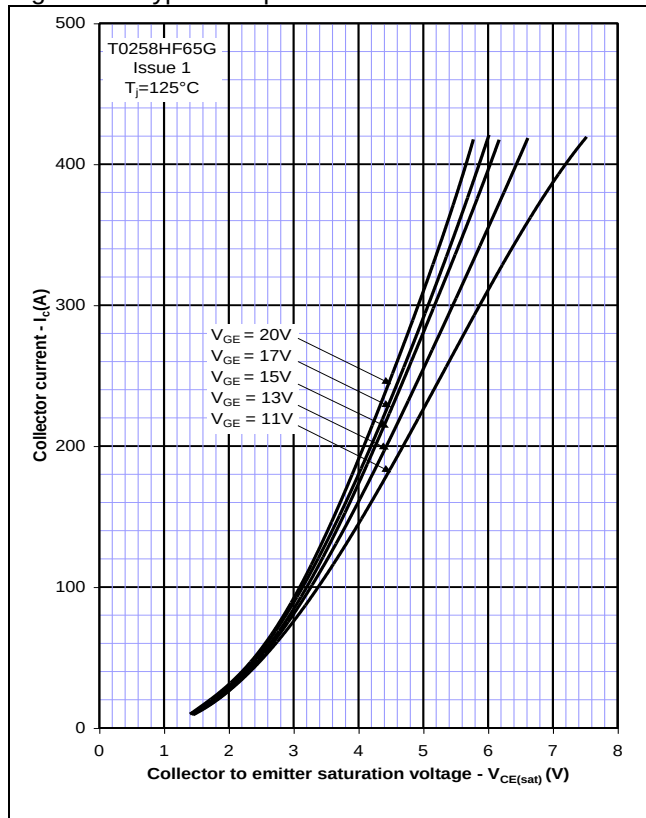


Figure 4 – Typical turn-on delay time vs gate resistance

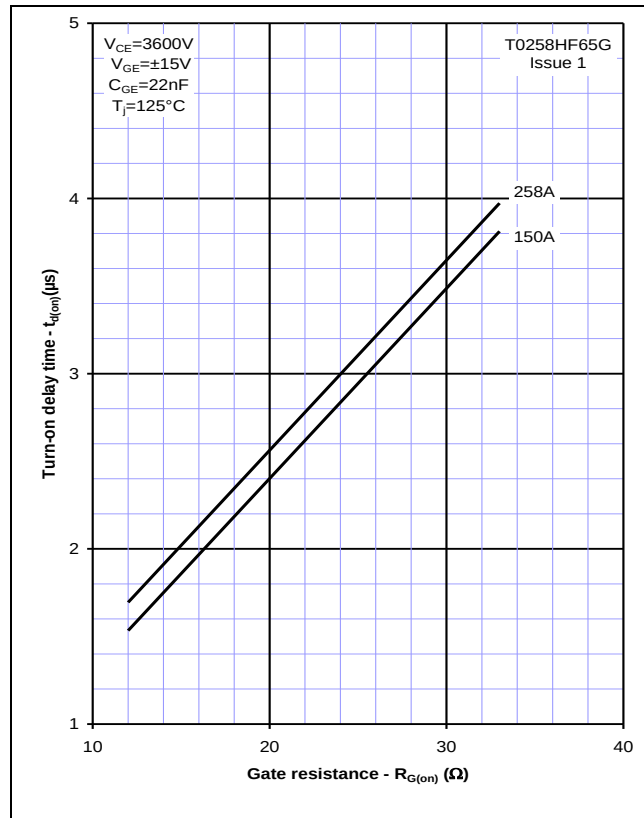


Figure 5 – Typical turn-off delay time vs. gate resistance

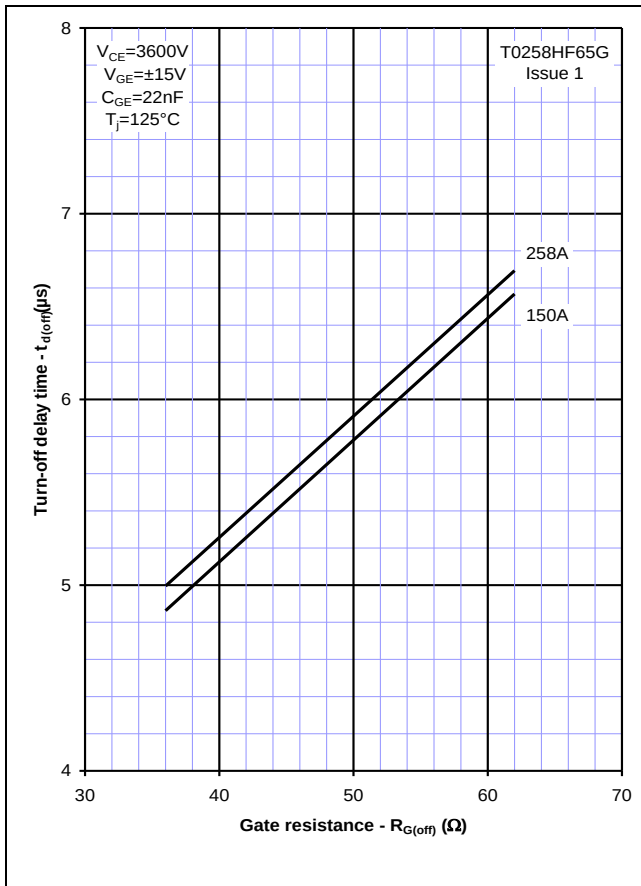


Figure 6 – Typical turn-on energy vs. collector current

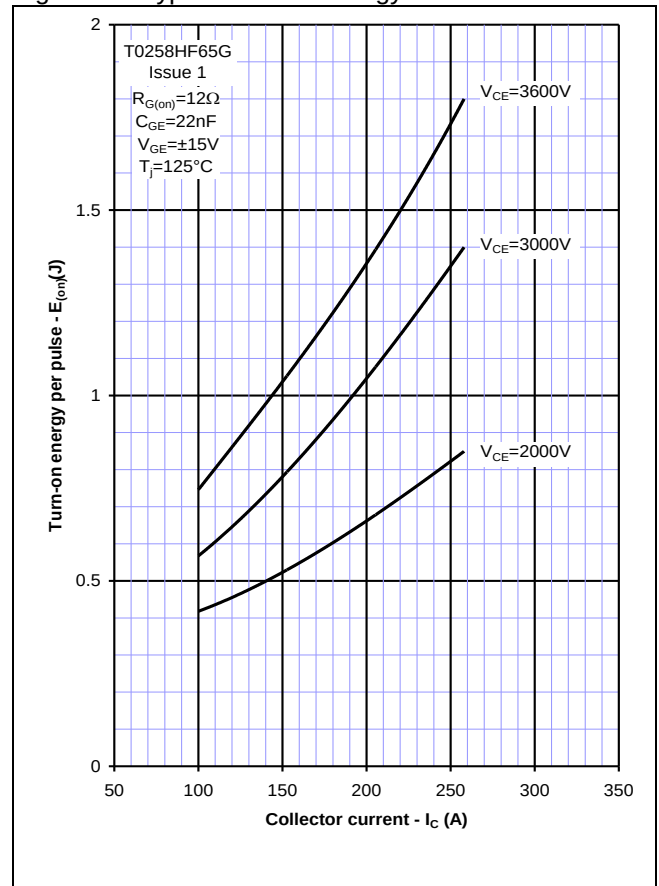


Figure 7 – Typical turn-on energy vs. di/dt

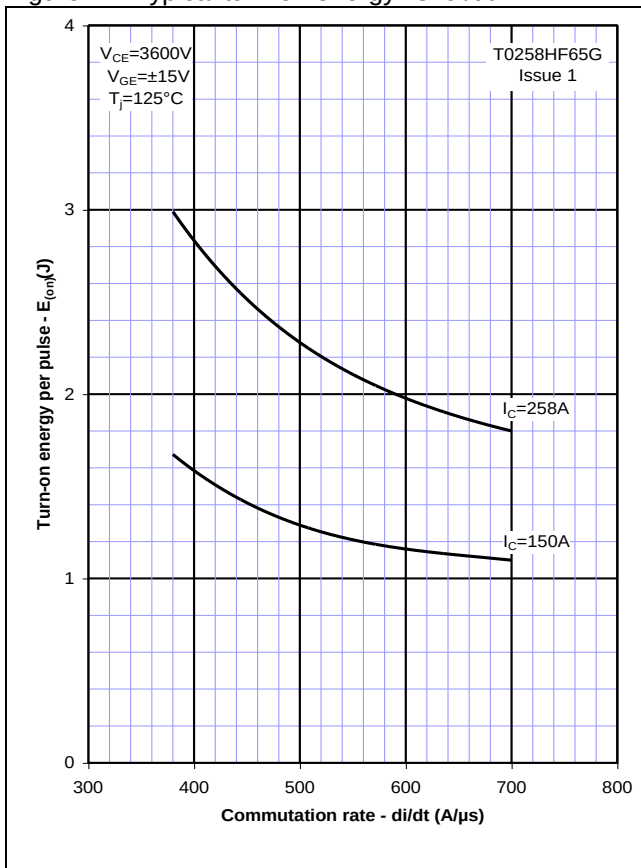


Figure 8 – Typical turn-off energy vs. collector current

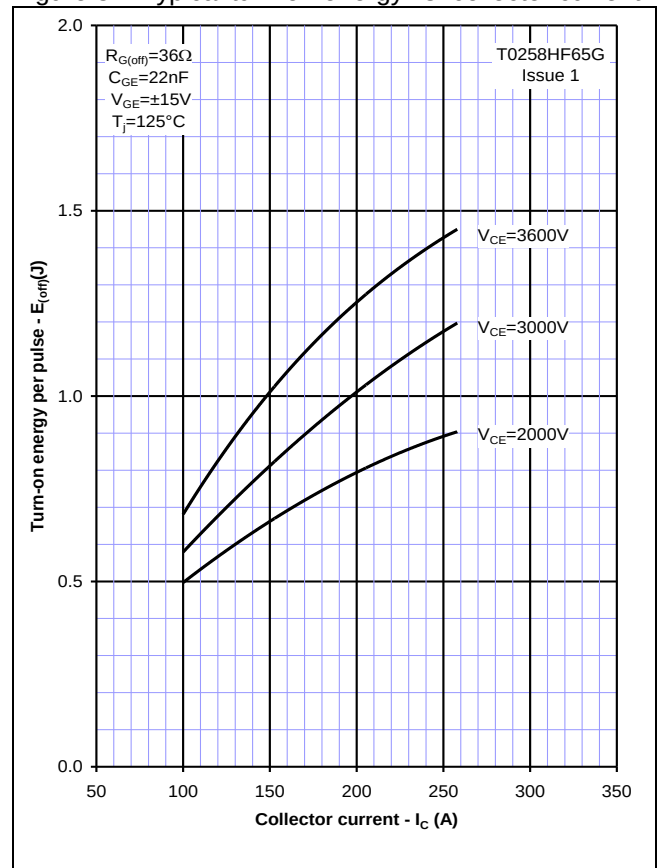


Figure 9 – Turn-off energy vs voltage

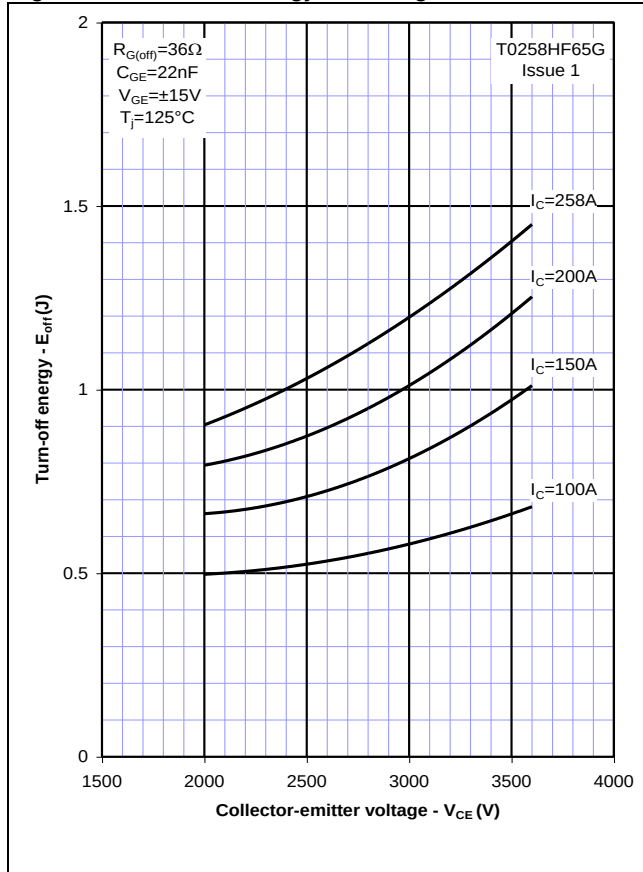


Figure 10 – Safe operating area (IGBT)

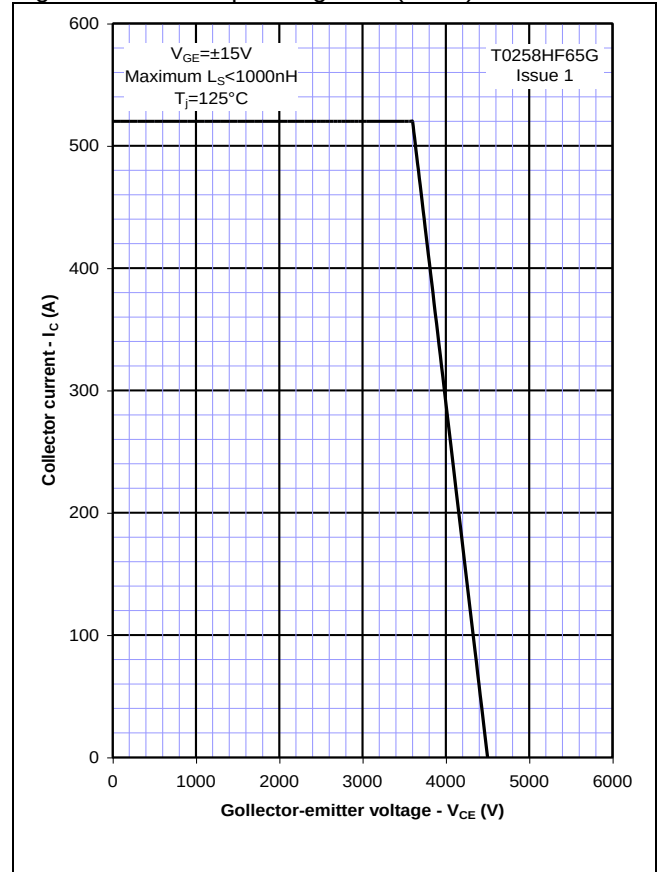


Figure 11 – Typical diode forward characteristics

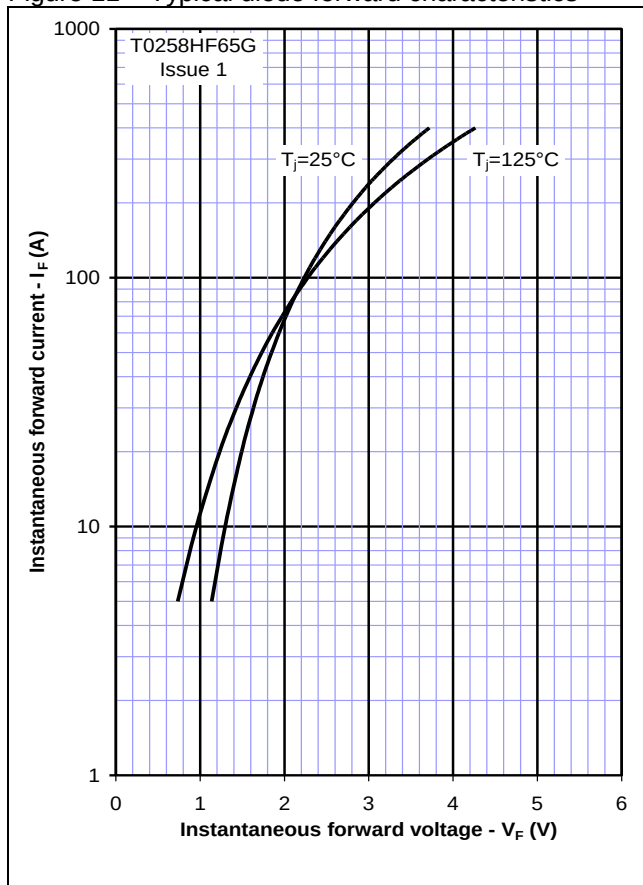


Figure 12 – Typical recovered charge

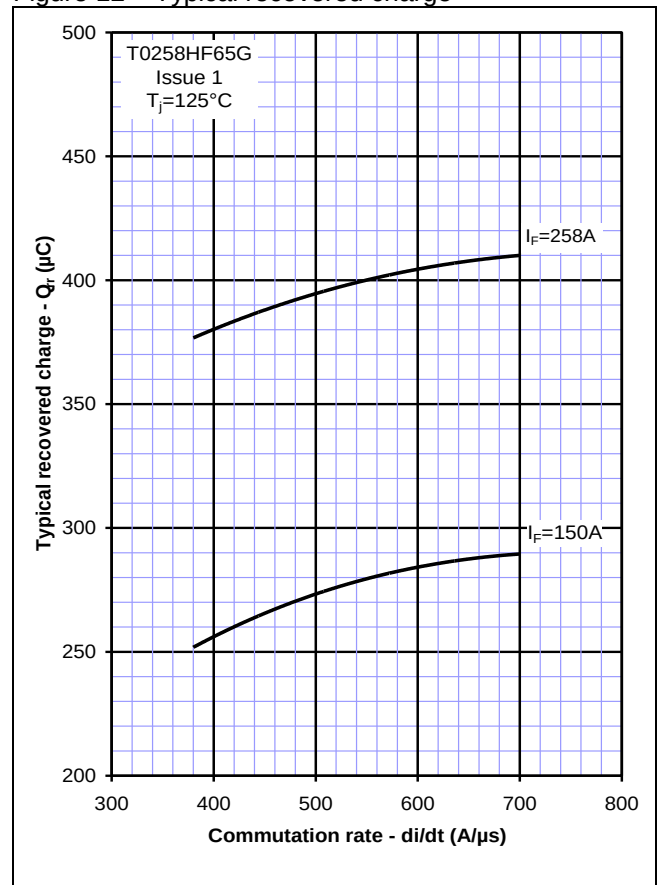


Figure 13 – Typical reverse recovery current

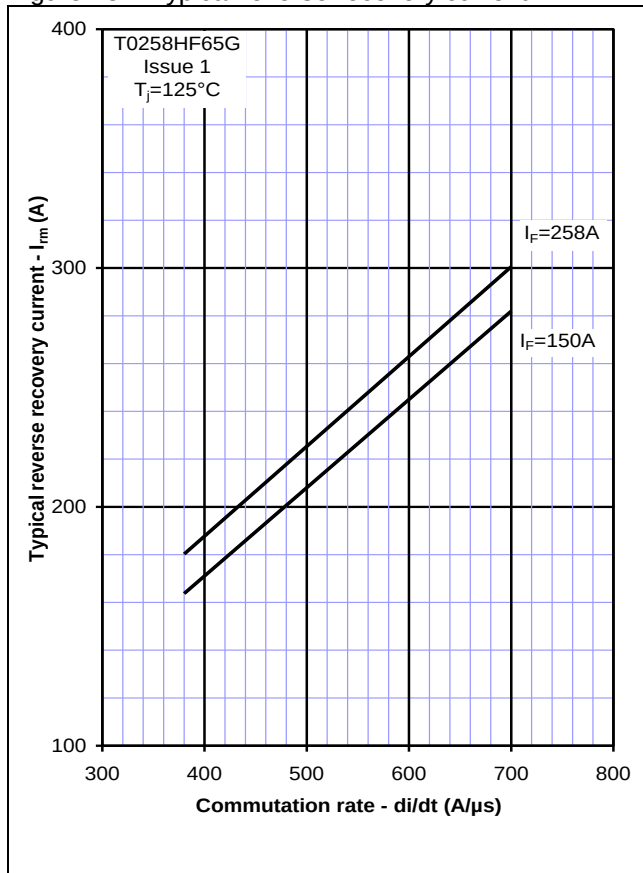


Figure 14 – Typical reverse recovery time

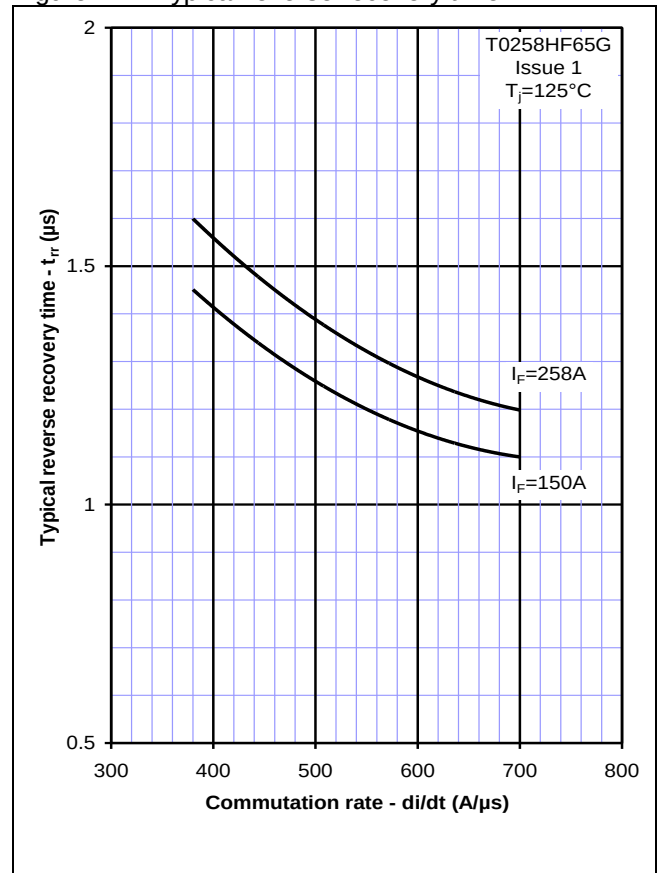


Figure 15 – Typical reverse recovery energy

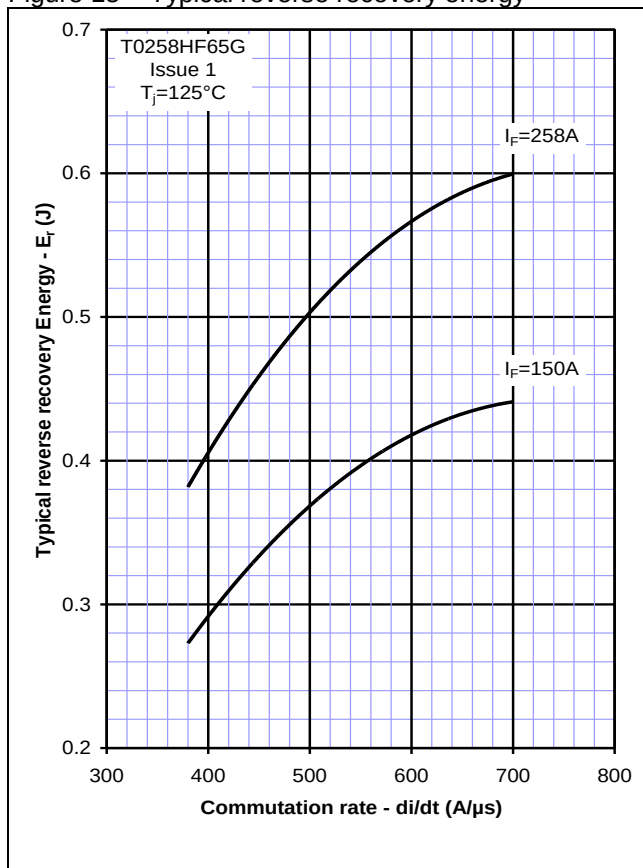


Figure 16 – Safe operating area (Diode)

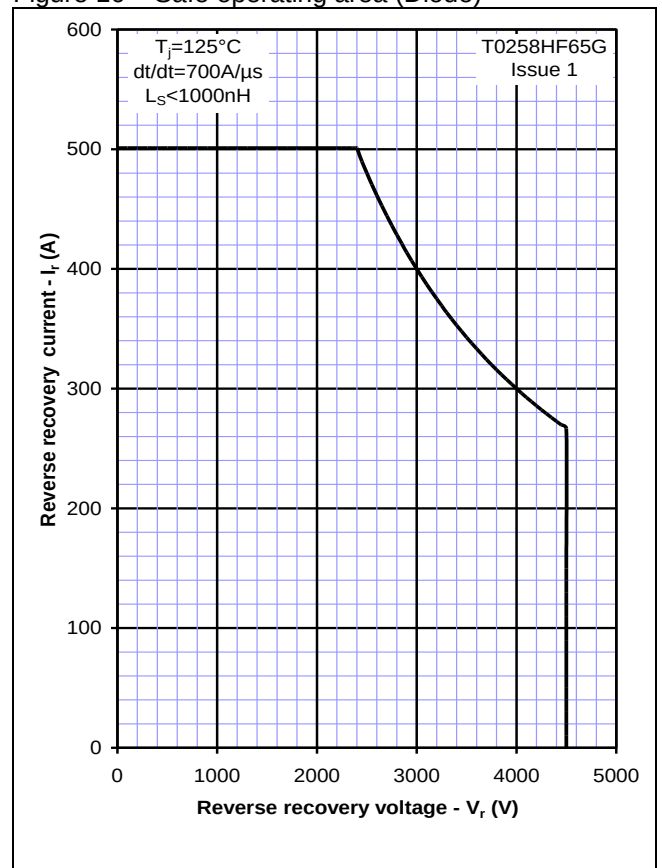


Figure 17 – Transient thermal impedance (IGBT)

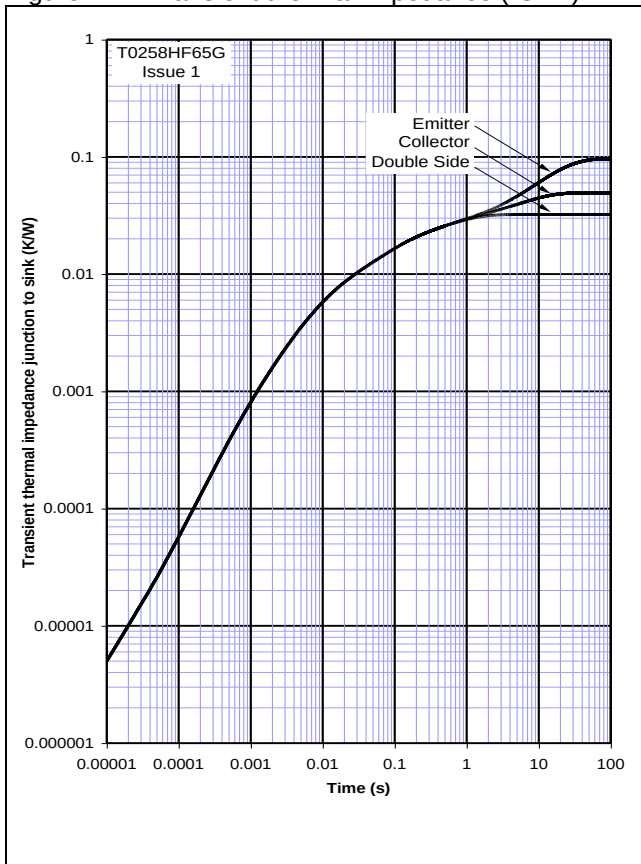
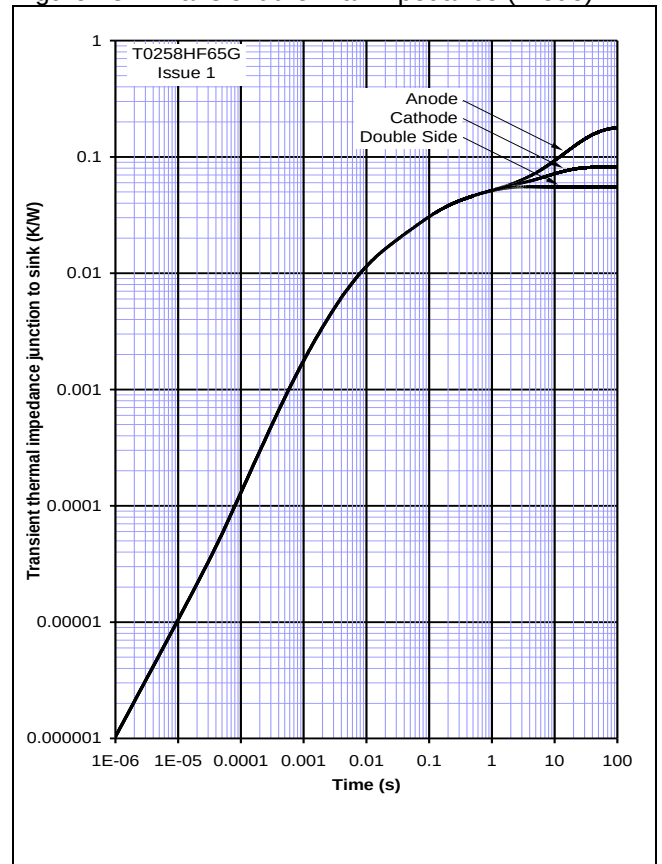
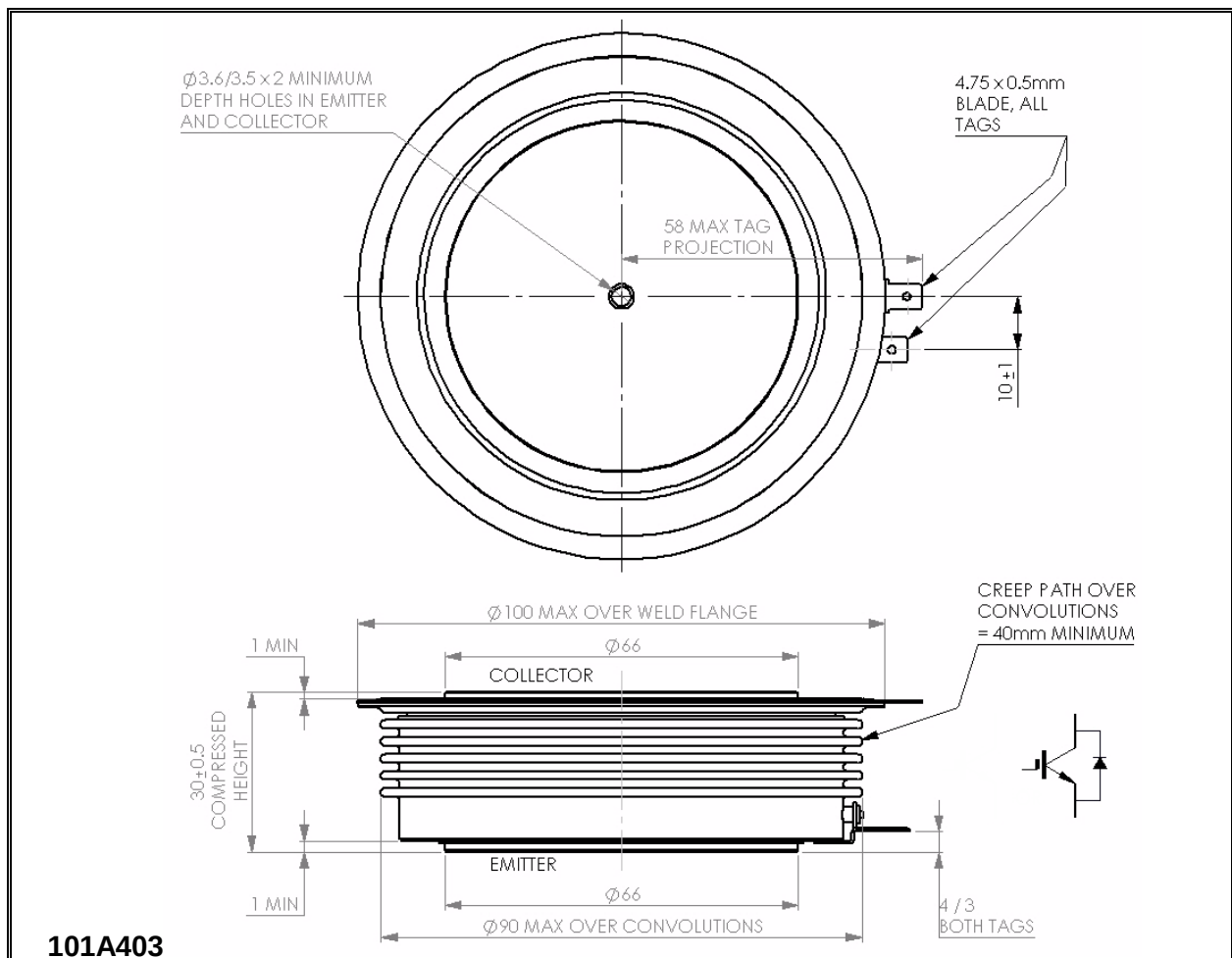


Figure 18 – Transient thermal impedance (Diode)



Outline Drawing & Ordering Information



ORDERING INFORMATION			
(Please quote 10 digit code as below)			
T0258	HF	65	G
Fixed type Code	Fixed Outline Code	Voltage Grade $V_{CES}/100$ 65	Fixed format code
Typical order code: T0258HF65G ($V_{CES} = 6500V$)			

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